



Express Mail No. EV343556791US

Attorney Docket No. 108298631US
Disclosure No. 01-0509

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: BOON SUAN JEUNG, *ET AL.*
APPLICATION No.: 10/033,340
FILED: DECEMBER 26, 2001
FOR: **MULTI-SUBSTRATE MICROELECTRONIC
PACKAGES AND METHODS FOR
MANUFACTURE**

EXAMINER: MAI HUONG C. TRAN
ART UNIT: 2818
CONF. No: 7237

Response Under 37 C.F.R. § 1.111

Mail Stop Non Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated May 22, 2003 in the above-identified application. The application has not been amended by this paper.

RECEIVED
AUG 27 2003
TECHNOLOGY CENTER 2800